



DMN3112S

N-CHANNEL ENHANCEMENT MODE MOSFET

Features

- Low On-Resistance:
 - $57m\Omega @ V_{GS} = 10V$ 112m $\Omega @ V_{GS} = 4.5V$
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Lead Free By Design/RoHS Compliant (Note 1)
- "Green" Device (Note 2)
- Qualified to AEC-Q101 Standards for High Reliability

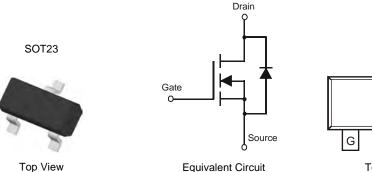
Mechanical Data

- Case: SOT23
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0

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- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208
- Terminal Connections: See Diagram
- Weight: 0.008 grams (approximate)



Top View Pin Configuration

Ordering Information (Note 3)

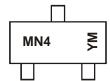
Part Number	Qualification	Case	Packaging
DMN3112S-7	Commercial	SOT23	3000/Tape & Reel
DMN3112SQ-7	Automotive	SOT23	3000/Tape & Reel

Notes: 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. No purposely added lead. Halogen and Antimony free.

2. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com.

3. For packaging details, go to our website at http://www.diodes.com.

Marking Information



MN4 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: V = 2008) M = Month (ex: 9 = September)

Date Code Key												
Year	2008	2009) 20	10	2011	2012	2013	2014	20	015	2016	2017
Code	V	W	>	<	Y	Z	А	В		С	D	E
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Maximum Ratings @T_A = 25°C unless otherwise specified

Characteristic		Symbol	Value	Unit
Drain Source Voltage		V _{DSS}	30	V
Gate-Source Voltage		V _{GSS}	±20	V
Drain Current (Note 4)	T _A = 25°C T _A = 70°C	ID	5.8 4.2	А
Drain Current (Note 4)	Pulsed	I _{DM}	20	A
Body-Diode Continuous Current (Note 4)		Is	2.0	А

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Total Power Dissipation (Note 4)	PD	1.4	W
Thermal Resistance, Junction to Ambient $@T_A = 25^{\circ}C$ (Note 4)	$R_{ ext{ heta}JA}$	90	°C/W
Operating and Storage Temperature Range	T _{J,} T _{STG}	-55 to +150	°C

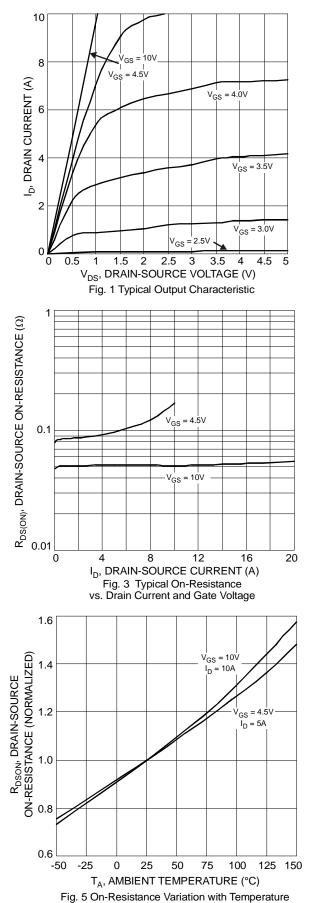
Electrical Characteristics $@T_A = 25^{\circ}C$ unless otherwise specified

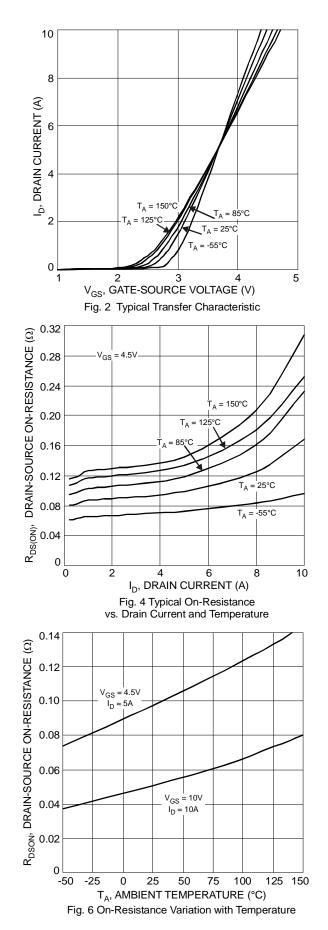
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
DFF CHARACTERISTICS (Note 5)							
Drain-Source Breakdown Voltage	BV _{DSS}	30	_	_	V	$V_{GS} = 0V, I_D = 250 \mu A$	
Zero Gate Voltage Drain Current	I _{DSS}	_		800	nA	$V_{DS} = 30V, V_{GS} = 0V$	
Gate-Body Leakage		_		±80 ±800	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$ $V_{GS} = \pm 25V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 5)							
Gate Threshold Voltage	V _{GS(th)}	1.3	1.9	2.2	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$	
Static Drain-Source On-Resistance	R _{DS (ON)}	_	47 92	57 112	mΩ	$V_{GS} = 10V, I_D = 5.8A$ $V_{GS} = 4.5V, I_D = 4.2A$	
Forward Transconductance	Y _{fs}	_	4.7		S	$V_{DS} = 5V, I_D = 4.2A$	
Source-Drain Diode Forward Voltage	V _{SD}	_	0.78	1.1	V	$V_{GS} = 0V, I_{S} = 2.0A$	
DYNAMIC CHARACTERISTICS							
Input Capacitance	C _{iss}	_	268		pF	$V_{DS} = 5V, V_{GS} = 0V$ f = 1.0MHz	
Output Capacitance	C _{oss}	_	73		pF		
Reverse Transfer Capacitance	C _{rss}	_	50		pF		

Notes:

4. Device mounted on FR-4 PCB. t \leq 5 sec. 5. Short duration pulse test used to minimize self-heating effect.



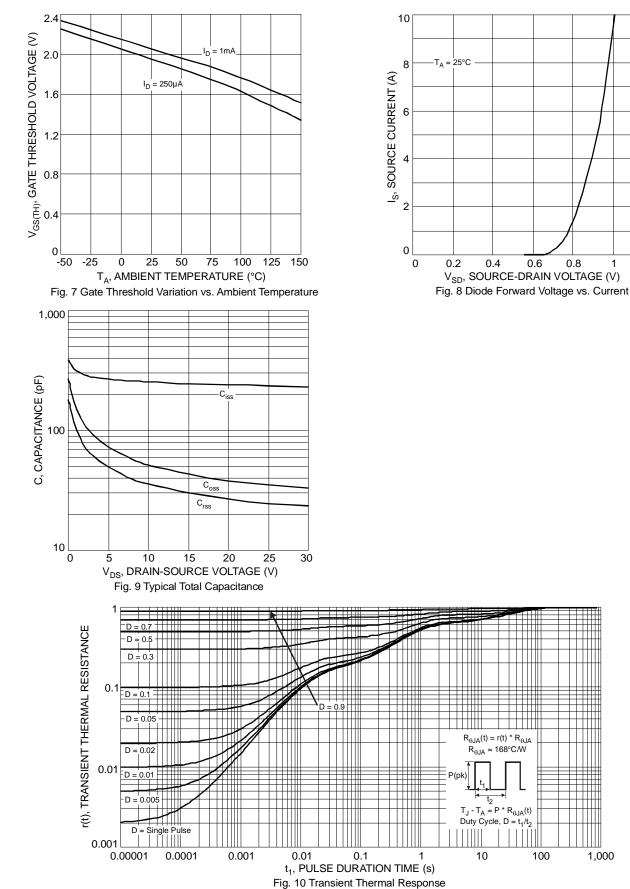




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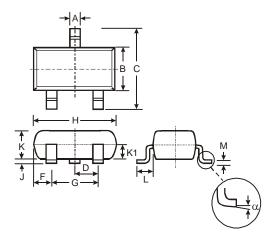




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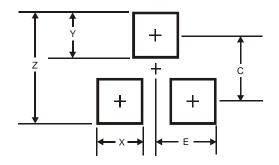


Package Outline Dimensions



SOT23						
Dim	Min	Max	Тур			
Α	0.37	0.51	0.40			
В	1.20	1.40	1.30			
С	2.30	2.50	2.40			
D	0.89	1.03	0.915			
F	0.45	0.60	0.535			
G	1.78	2.05	1.83			
Н	2.80	3.00	2.90			
J	0.013	0.10	0.05			
Κ	0.903	1.10	1.00			
K1	-	-	0.400			
L	0.45	0.61	0.55			
М	0.085	0.18	0.11			
α	0°	8°	-			
All Dimensions in mm						

Suggested Pad Layout



Dimensions	Value (in mm)
Z	2.9
Х	0.8
Y	0.9
С	2.0
E	1.35



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